

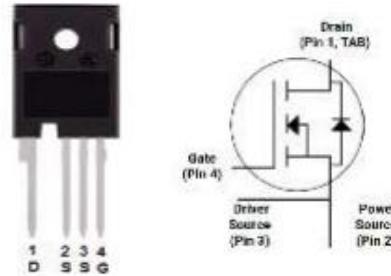
Silicon Carbide Power MOSFET 1200V, 55A, 40mΩ

General Description

This product family offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required.

Features

- High Blocking Voltage
- High Frequency Operation
- Low on-resistance
- Fast intrinsic diode with low reverse recovery



TO-247-4
Pin definition

Applications

- Motor Drives
- Solar / Wind Inverters
- EV Charging Station
- AC/DC converters
- DC/DC converters
- Uninterruptable power supplies

Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- High Temperature Application
- Hard Switching & Higher Reliability
- Easy to drive

Key performance parameters

Type	V_{DS}	I_D $T_C=25^\circ C$	$R_{DS(ON)}$
KN3M0040120Q	1200V	55A	40mΩ

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures.

Maximum Ratings

$T_C=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Test conditions	Value	Unit
Drain - Source Voltage	$V_{DS\max}$	$V_{GS} = 0\text{V}$, $I_D = 100\mu\text{A}$	1200	V
Gate - Source Voltage (dynamic)	$V_{GS\max}$	AC ($f > 1 \text{ Hz}$)	-10/+25	V
Gate - Source Voltage (static)	V_{GSop}	static	-5/+20	V

Maximum Ratings

$T_C=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous Drain Current: $V_{GS} = 20\text{V}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_D	55 39	A
Pulsed Drain Current: $T_C = 25^\circ\text{C}$	$I_{D(\text{pulse})}$	117	A
Short Circuit Capability : $V_{DD} = 800\text{V}$ $V_{GS} = 20\text{V}$	tsc	3	μS
Short Circuit Capability : $V_{DD} = 800\text{V}$ $V_{GS} = 20\text{V}$	I_{DS}	600	A
Total power dissipation : $T_C = 25^\circ\text{C}$	P_D	300	W
Operating Junction Temperature :	T_j	-55 to 175	$^\circ\text{C}$
Storage Temperature :	T_{stg}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Condition	Typ	Max	Unit
Thermal Resistance (per device)	$R_{\text{th(j-c)}}$	junction-case	0.35	0.5	$^\circ\text{C/W}$

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Electrical Characteristic

$T_C = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit	Test Condition	
		Min.	Typ.	Max.			
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	1200			V	$V_{GS} = 0\text{V}$ $I_D = 100\mu\text{A}$	
Gate Threshold Voltage	$V_{GS(\text{th})}$	1.8	3.5 2.6 2.5	3.9	V	$V_{DS} = V_{GS}$ $I_D = 10\text{mA}$ $T_J = 150^\circ\text{C}$ $T_J = 175^\circ\text{C}$	
Zero Gate Voltage Drain Current	I_{DSS}	0	5	100	μA	$V_{DS} = 1200\text{V}$ $V_{GS} = 0\text{V}$	
Gate-Source Leakage Current	I_{GSS}	0 -200	10 -10	200 0	nA	$V_{GS} = 20\text{V}$ $V_{DS} = 0\text{V}$ $V_{GS} = -5\text{V}$ $V_{DS} = 0\text{V}$	
Drain-Source On-State Resistance	$R_{DS(\text{on})}$		40 61 69	44	$\text{m}\Omega$	$V_{GS} = 20\text{V}$ $I_D = 40\text{ A}$ $T_J = 150^\circ\text{C}$ $T_J = 175^\circ\text{C}$	
Transconductance	g_{fs}		22 20 19		S	$V_{GS} = 20\text{V}$ $I_D = 40\text{ A}$ $T_J = 150^\circ\text{C}$ $T_J = 175^\circ\text{C}$	
Input capacitance	C_{iss}		2930		pF	$V_{DS} = 1000\text{V}$ $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$	
Output capacitance	C_{iss}		149				
Reverse transfer capacitance	C_{rss}		9				
Coss Stored Energy	E_{oss}		87		μJ	$V_{DS} = 800\text{V}$ $V_{GS} = -5\text{V} / 20\text{V}$ $I_D = 40\text{ A}$	
Total gate charge	Q_g		145		nC		
Gate-source charge	Q_{gs}		43				
Gate-drain charge	Q_{gd}		73		$f = 1\text{MHz}$ $I_D = 0\text{A}$	$V_{DS} = 800\text{V}$ $V_{GS} = -5\text{V}/20\text{V}$ $I_D = 40\text{A}$ $R_{G(\text{ext})} = 1.5\ \Omega$ $L = 450\mu\text{H}$	
Internal gate input resistance	$R_{g(\text{int})}$		2				
Turn-On Switching Energy	E_{ON}		609				
Turn-Off Switching Energy	E_{OFF}		439		μJ	$V_{DS} = 800\text{V}$ $V_{GS} = -5\text{V}/20\text{V}$ $I_D = 40\text{A}$ $R_{G(\text{ext})} = 1.5\ \Omega$ $L = 450\mu\text{H}$	

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Turn-On Delay Time	$t_{d(on)}$	22		ns	$V_{DS} = 800V$ $V_{GS} = -5V/20V$ $I_D = 40A \quad R_{G(ext)} = 1.5 \Omega$ $L = 450\mu H$	
Rise Time	tr	34				
Turn-Off Delay Time	$t_{d(off)}$	36				
Fall Time	t_f	20				
Avalanche Capability	E_{AS}	676		mJ	$V_{DD} = 100V \quad V_{GS}=20V$ $L = 2mH$	
	I_{AV}	26		A		

Reverse Diode Characteristics

$T_C = 25^\circ C$, unless otherwise specified

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
Diode Forward Voltage	V_{SD}		3.9 3.5 3.4		V	$V_{GS} = -5V \quad I_{SD} = 20A$ $T_J = 150^\circ C \quad T_J = 175^\circ C$
Continuous Diode Forward Current	I_S		70		A	$V_{GS} = -5V$
Reverse Recovery time	t_{rr}		20		ns	$V_{GS} = -5V \quad I_{SD} = 40A$ $V_R = 800V$ $dif/dt = 4000 A/\mu s$
Reverse Recovery Charge	Q_{rr}		375		nC	
Peak Reverse Recovery Current	I_{rrm}		31		A	

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Typical Performance

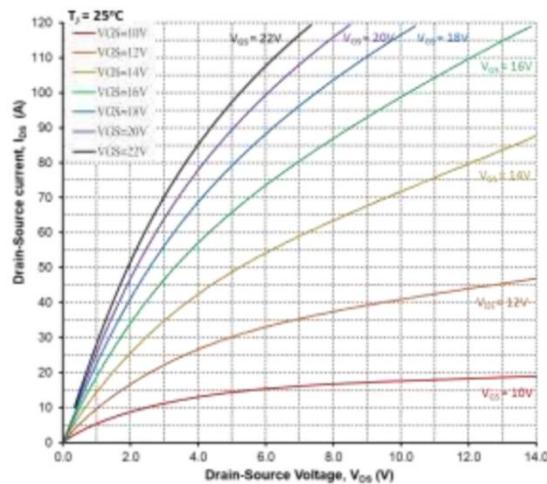


Figure 1. Output Characteristics, $T_J = 25^\circ\text{C}$

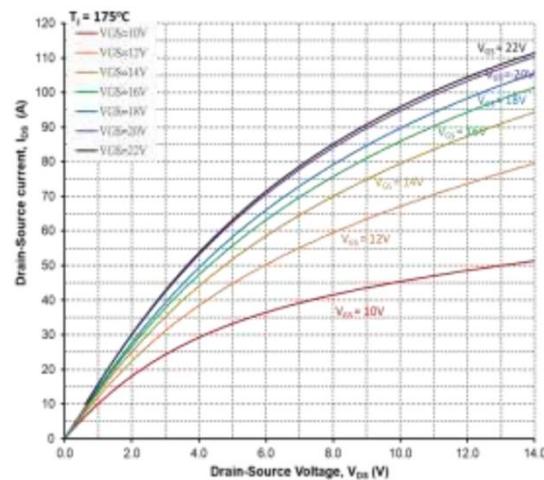


Figure 2. Output Characteristics, $T_J = 175^\circ\text{C}$

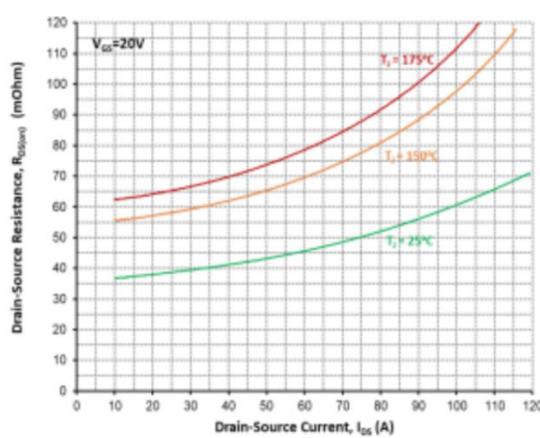


Figure 3. On-Resistance vs. Drain Current
For Various Temperatures

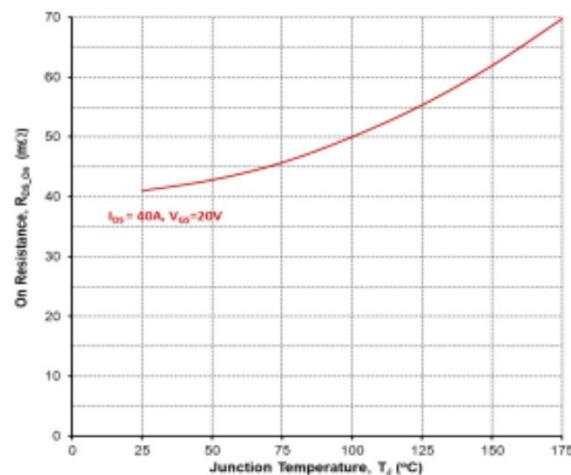


Figure 4. On-Resistance vs. Temperature

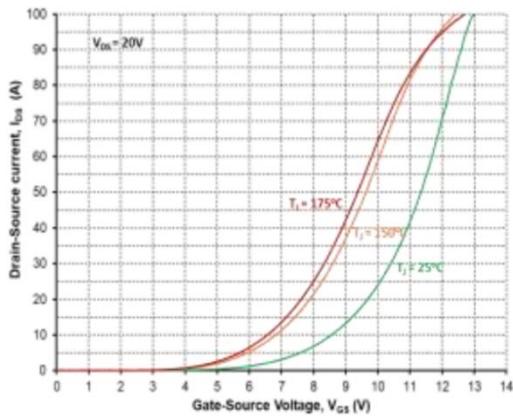


Figure 5. Transfer Characteristic For Various Junction
Temperatures

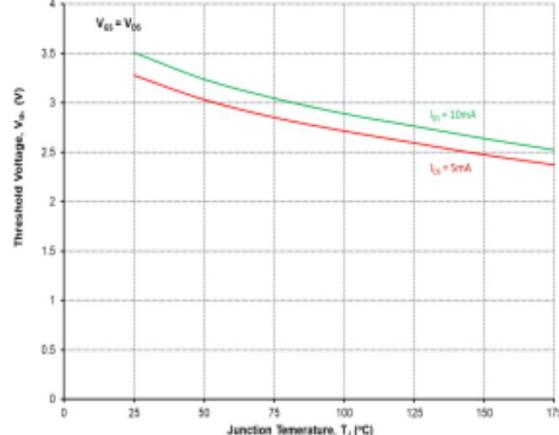


Figure 6. Threshold Voltage vs. Temperature

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handing procedures.

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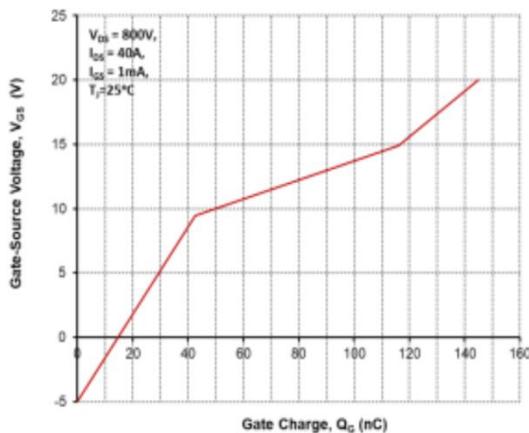


Figure 7. Gate Charge Characteristics

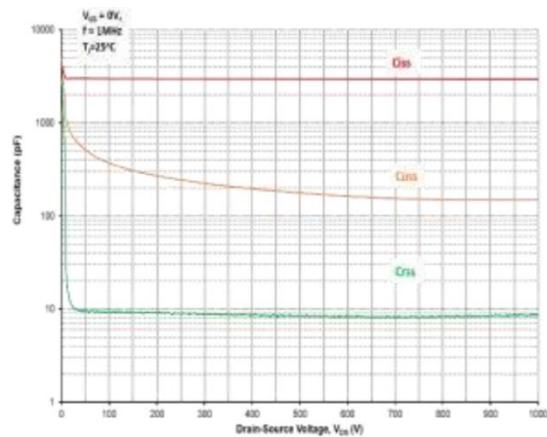


Figure 8. Capacitances vs. Drain-Source Voltage (0-1000V)

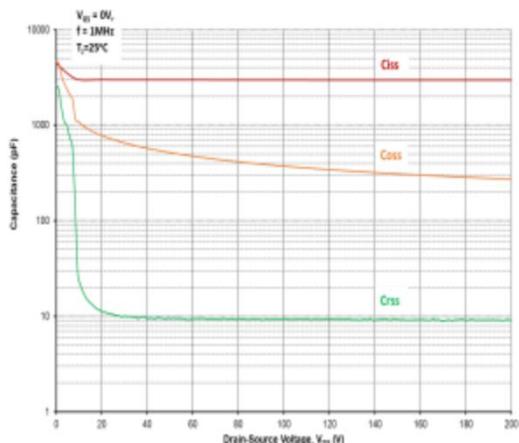


Figure 9. Capacitances vs. Drain-Source Voltage (0-200V)

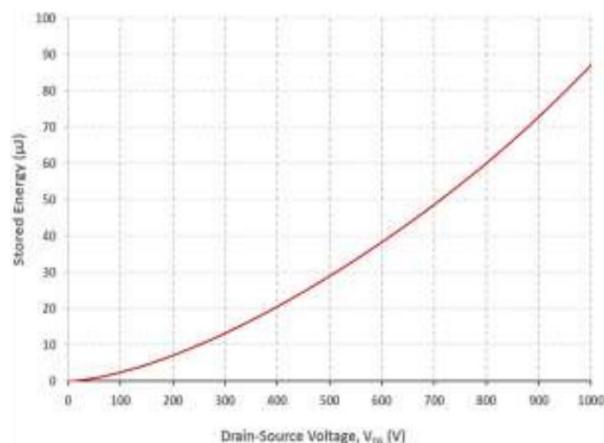


Figure 10. Output Capacitor Stored Energy

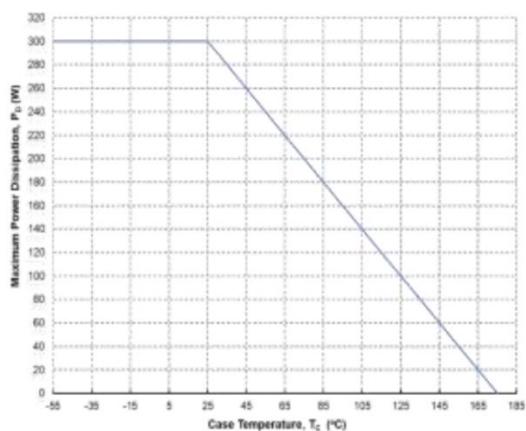


Figure 11. Maximum Power Dissipation Derating vs. Case Temperature

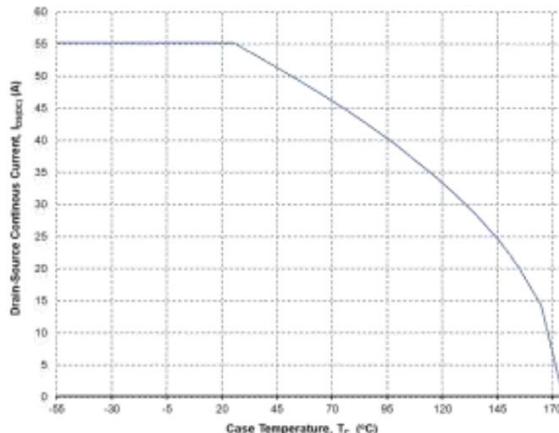


Figure 12. Continuous Drain Current Derating vs. Case Temperature

cedures.

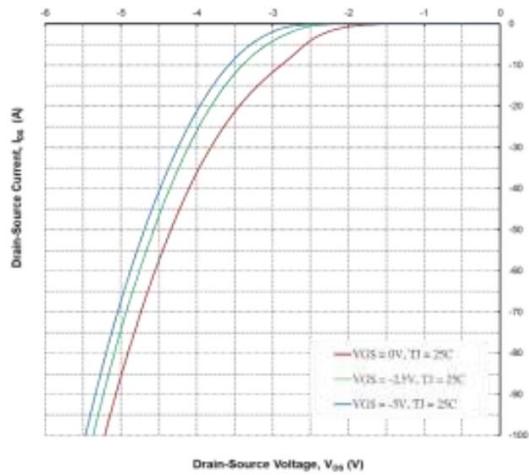


Figure 13. Body Diode Characteristics @ 25°C

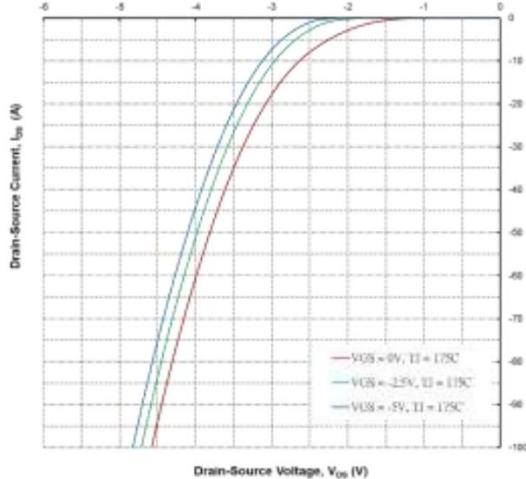


Figure 14. Body Diode Characteristics @ 175°C

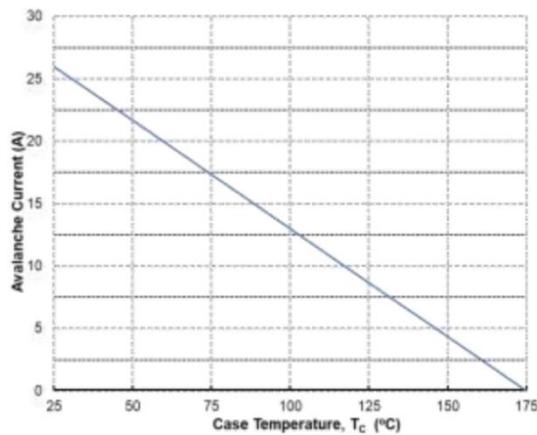


Figure 15. Single Avalanche vs. Temperature

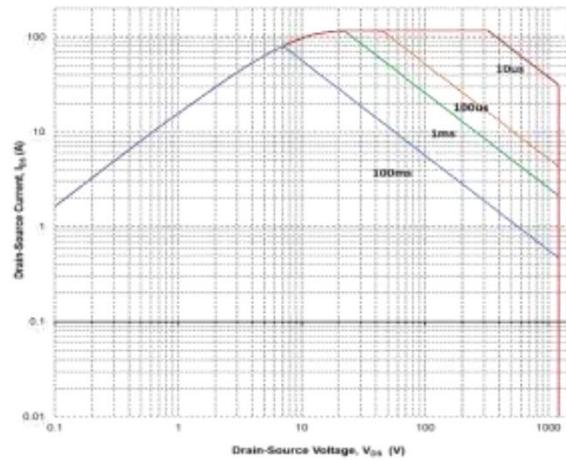
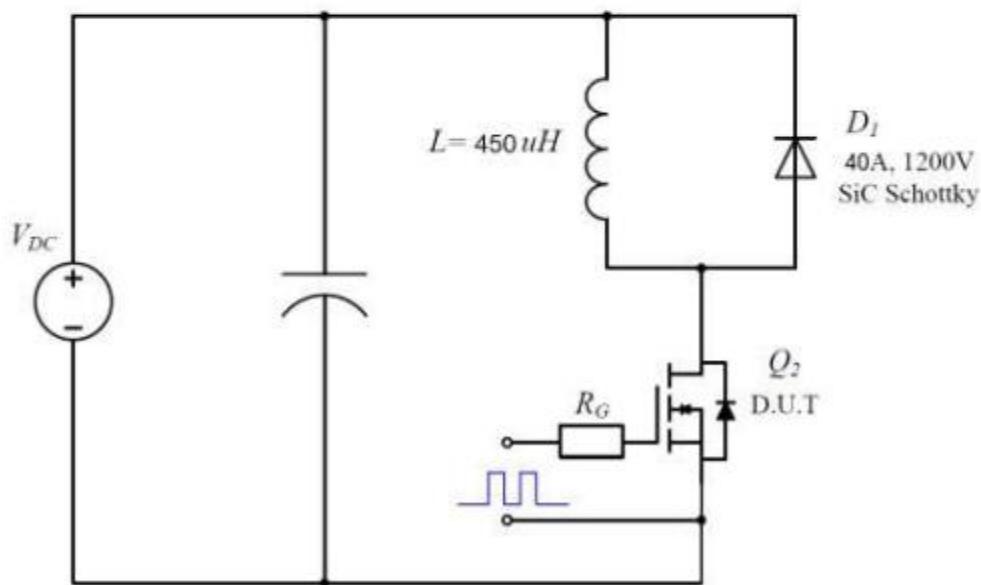
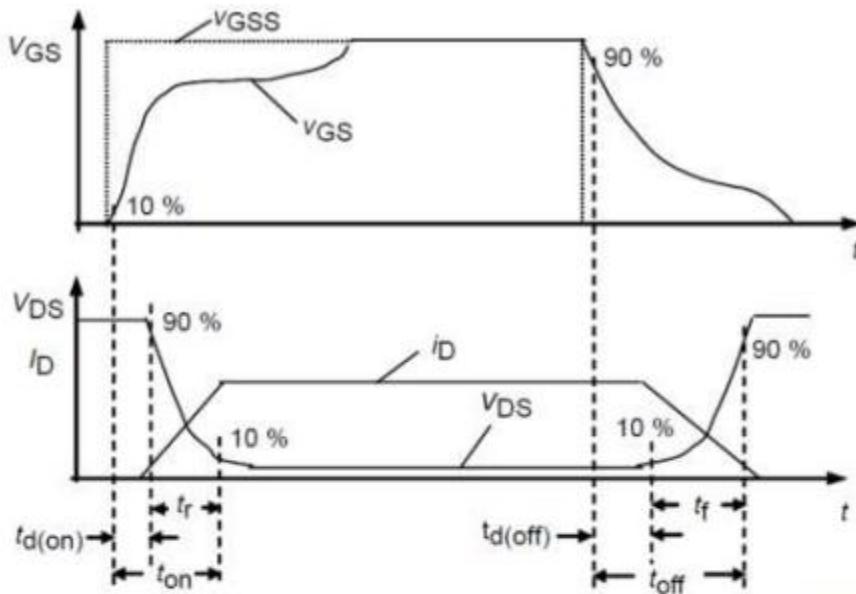


Figure 16. Safe Operating Area

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.

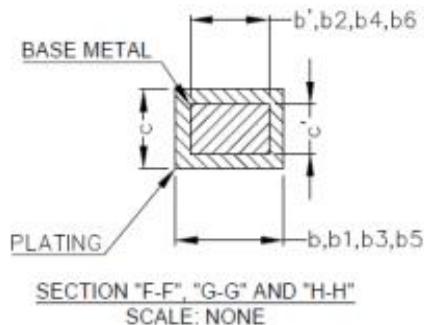
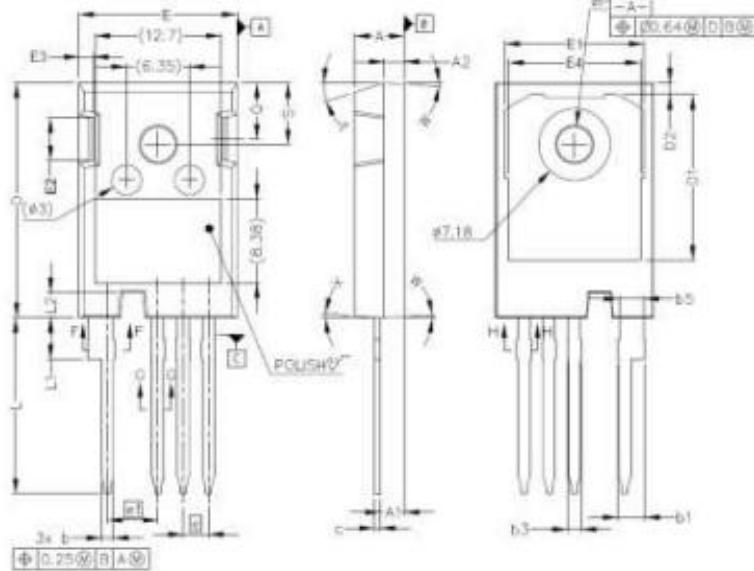
Switching Times Definition and Test Circuit



Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.

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Package Outline: TO-247-4



SYMBOL	MILLIMETERS	
	MIN	MAX
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b'	1.07	1.28
b	1.07	1.33
b1	2.39	2.94
b2	2.39	2.84
b3	1.07	1.60
b4	1.07	1.50
b5	2.39	2.69
b6	2.39	2.64
c'	0.55	0.65
c	0.55	0.68
D	23.30	23.60
D1	16.25	17.65
D2	0.95	1.25
E	15.75	16.13
E1	13.10	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
e	2.54 BSC	
e1	5.08 BSC	
N	4	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
øP	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
T	17.5° REF.	
W	3.5 ° REF.	
X	4° REF.	

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